

#### ABSTRACT OF THE DISCLOSURE

An imaging portion of an imaging apparatus according to the present invention has a cover glass adhered by an adhesive to an imaging surface side of a CCD in a state of sandwiching leads (adhesion area  $B_1$ ), and has a slight airtight air gap formed on the imaging surface side of the CCD so as to render a circumference of the cover glass larger than the CCD. As for a circuit board, a concave portion for accommodating the CCD is formed, and a periphery of the cover glass is adhered to a top surface of the circuit board by the adhesive (adhesion area  $B_2$ ). Thus, the air gap is doubly sealed so that its airtightness is improved and influence of temperature change is reduced so as to prevent condensation on a back side of the cover glass and so on.